

UNISONIC TECHNOLOGIES CO., LTD

2N65-TD **Preliminary Power MOSFET**

2A, 650V N-CHANNEL POWER MOSFET

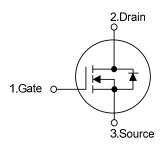
DESCRIPTION

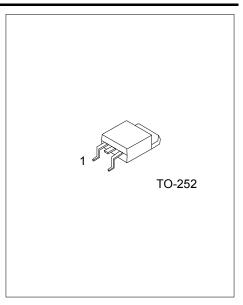
The UTC 2N65-TD is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)} \le 5.0 \Omega @ V_{GS} = 10V, I_D = 1.0A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL

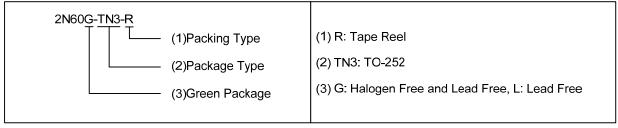




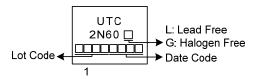
ORDERING INFORMATION

Ordering Number		Daalaasa	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N65L-TN3-R	2N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	650	V
Gate-Source Voltage		V_{GSS}	±30	>
Continuous Drain Current		I_{D}	2	Α
Pulsed Drain Current (Note 2)		I_{DM}	4	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	108.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4	V/ns
Power Dissipation		P_D	44.5	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 2.6A, V_{DD} = 80V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 2.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ_{JC}	2.8 (Note)	°C/W	

Note: Device mounted on FR-4 substrate P_C board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

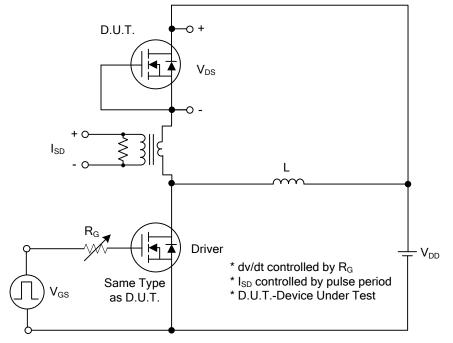
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS		_					-
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	650			V
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ
Gate- Source Leakage Current	Forward	I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse	IGSS	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 1.0A$			5.0	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}			234.1		рF
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		30.8		рF
Reverse Transfer Capacitance		C _{RSS}			2.7		рF
SWITCHING CHARACTERISTIC	S	_					-
Total Gate Charge (Note 1)		Q_G	\/ -F20\/ \/ -40\/ \ -2.0A		11.3		nC
Gate-Source Charge		Q_GS	V _{DS} =520V, V _{GS} =10V, I _D =2.0A,		4.2		nC
Gate-Drain Charge		Q_GD	I _D =1mA (Note 1, 2)		1.9		nC
Turn-On Delay Time (Note 1)		t _{D(ON)}			6.7		ns
Turn-On Rise Time		t _R	V_{DD} =100V, V_{GS} =10V, I_{D} =2.0A,		15.7		ns
Turn-Off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		24.4		ns
Turn-Off Fall Time		t _F			28.7		ns
DRAIN-SOURCE DIODE CHARA	CTERISTIC	CS AND MA	XIMUM RATINGS				
Maximum Body-Diode Continuous Current		Is				2	Α
Maximum Body-Diode Pulsed Current		I _{SM}				4	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =2.0A , V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}			193.3		ns
Body Diode Reverse Recovery Charge		Qrr	I _S =2.0A , V _{GS} =0V di/dt=100A/μs		1.7		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

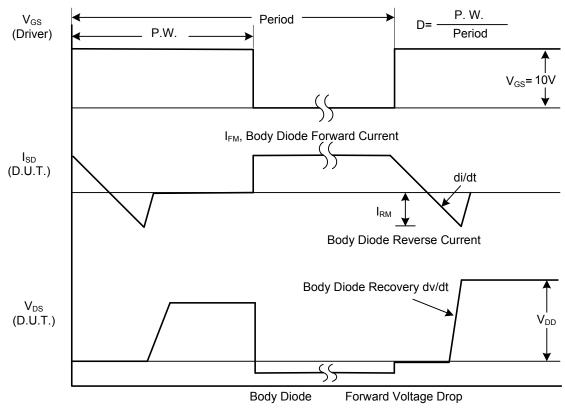
2. Essentially independent of operating temperature.



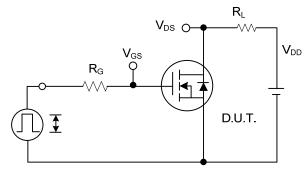
TEST CIRCUITS AND WAVEFORMS



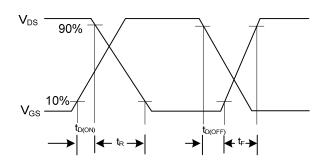
Peak Diode Recovery dv/dt Test Circuit



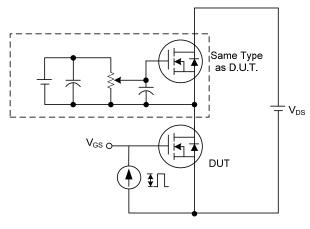
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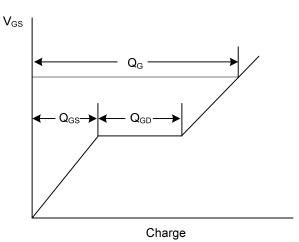
Switching Test Circuit



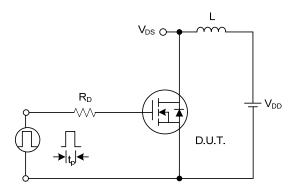
Switching Waveforms



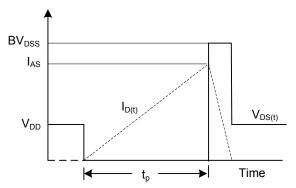
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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